#### **Features**

- Fast Read Access Time 80 ns
- Low Power CMOS Operation
   100 μA max. Standby

30 mA max. Active at 5 MHz

- JEDEC Standard Packages
  - 32-Lead 600-mil PDIP
  - 32-Lead 450-mil SOIC (SOP)
  - 32-Lead PLCC
  - 32-Lead TSOP
- 5V ± 10% Supply
- High Reliability CMOS Technology
  - 2000V ESD Protection
  - 200 mA Latchup Immunity
- Rapid<sup>™</sup> Programming Algorithm 100 µs/byte (typical)
- CMOS and TTL Compatible Inputs and Outputs
- Integrated Product Identification Code
- Commercial and Industrial Temperature Ranges

#### **Description**

The AT27C040 chip is a low-power, high-performance 4,194,304 bit one-time programmable read only memory (OTP EPROM) organized as 512K by 8 bits. The AT27C040 requires only one 5V power supply in normal read mode operation. Any byte can be accessed in less than 80 ns, eliminating the need for speed reducing WAIT states on high-performance microprocessor systems.

Atmel's scaled CMOS technology provides low active power consumption, and fast programming. Power consumption is typically 8 mA in active mode and less than 10  $\,\mu\text{A}$  in standby mode.

(continued)

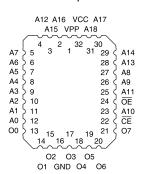
### **Pin Configurations**

Pin Name	Function
A0 - A18	Addresses
O0 - O7	Outputs
CE	Chip Enable
ŌE	Output Enable

PDIP, SOIC Top View

					_	
			$\bigcirc$		L	
VPP	Ц	1		32	۲	VCC
A16		2		31	Ρ	A18
A15	$\Box$	3		30	Þ	A17
A12		4		29	Þ	A14
Α7		5		28	P	A13
A6		6		27	Þ	A8
A5		7		26	Þ	A9
A4		8		25	Þ	A11
А3		9		24	Þ	ŌĒ
A2		10		23	Þ	A10
A1		11		22	Þ	CE
A0		12		21	Þ	07
00		13		20	Þ	O6
01		14		19	Þ	O5
02		15		18		O4
GND		16		17	Þ	О3
					J	

PLCC Top View



TSOP Top View

Type 1

ŌE A9 🗏 31 A10 Α8 CE A14 A13 30 29 07 28 06 A17 27 O5 VPP VCC 26 04 25 О3 GND 02 A16 01 22 21 00 20 19 A1 18 17 A3 A12 <sup>20</sup> 19 A0 14 Α5 A2 16

4 Megabit (512K x 8) OTP CMOS EPROM

0189D





#### **Description** (Continued)

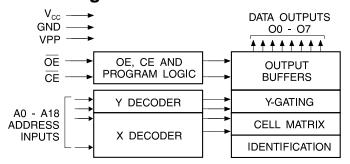
The AT27C040 is available in a choice of industry standard JEDEC-approved one-time programmable (OTP) plastic PDIP, PLCC, SOIC (SOP), and TSOP packages. The device features two-line control (CE, OE) to eliminate bus contention in high-speed systems.

Atmel's AT27C040 has additional features to ensure high quality and efficient production use. The Rapid Programming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100  $\mu$ s/byte. The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry standard programming equipment to select the proper programming algorithms and voltages.

#### **System Considerations**

Switching between active and standby conditions via the Chip Enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed data sheet limits, resulting in device non-conformance. At a minimum, a 0.1  $\mu F$  high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the Vcc and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7  $\mu F$  bulk electrolytic capacitor should be utilized, again connected between the Vcc and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

#### **Block Diagram**



#### **Absolute Maximum Ratings\***

Temperature Under Bias55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground2.0V to +7.0V (1)
Voltage on A9 with Respect to Ground2.0V to +14.0V (1)
V <sub>PP</sub> Supply Voltage with Respect to Ground2.0V to +14.0V <sup>(1)</sup>

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V dc which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V<sub>CC</sub> + 0.75V dc which may overshoot to +7.0V for pulses of less than 20 ns.

#### **Operating Modes**

Mode \ Pin	CE	ŌE	Ai	Vpp	Outputs
Read	VIL	VIL	Ai	X <sup>(1)</sup>	D <sub>OUT</sub>
Output Disable	X	VIH	Χ	Χ	High Z
Standby	VIH	X	Χ	Χ	High Z
Rapid Program (2)	VIL	VIH	Ai	$V_{PP}$	D <sub>IN</sub>
PGM Verify	X	VIL	Ai	VPP	Dout
PGM Inhibit	VIH	VIH	Χ	$V_{PP}$	High Z
Product Identification (4)	VIL	$V_{IL}$	$A9 = V_H^{(3)}$ $A0 = V_{IH} \text{ or } V_{IL}$ $A1 - A18 = V_{IL}$	Х	Identification Code

Notes: 1. X can be V<sub>IL</sub> or V<sub>IH</sub>.

2. Refer to Programming characteristics.

3.  $V_H = 12.0 \pm 0.5 V$ .

4. Two identifier bytes may be selected. All Ai inputs are held low (V<sub>IL</sub>), except A9 which is set to V<sub>H</sub> and A0 which is toggled low (V<sub>IL</sub>) to select the Manufacturer's Identification byte and high (V<sub>IH</sub>) to select the Device Code byte.





## **DC and AC Operating Conditions for Read Operation**

		AT27C040						
		-80	-10	-12	-15			
Operating	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C	0°C - 70°C			
Temperature (Case)	Ind.	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C			
Vcc Power Supply		5V ± 5%	5V ± 10%	5V ± 10%	5V ± 10%			

#### **DC and Operating Characteristics for Read Operation**

Symbol	Parameter	Condition	Min	Max	Units
ILI	Input Load Current	$V_{IN} = 0V$ to $V_{CC}$		±1	μΑ
ILO	Output Leakage Current	$V_{OUT} = 0V$ to $V_{CC}$		±5	μΑ
I <sub>PP1</sub> (2)	V <sub>PP</sub> <sup>(1)</sup> Read/Standby Current	VPP = VCC		10	μΑ
Lon	V <sub>CC</sub> <sup>(1)</sup> Standby Current	$I_{SB1}$ (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$		100	μΑ
I <sub>SB</sub>	VCC ** Standby Current	I <sub>SB2</sub> (TTL), $\overline{CE} = 2.0 \text{ to V}_{CC} + 0.5 \text{V}$		1	mA
Icc	V <sub>CC</sub> Active Current	$\frac{f = 5 \text{ MHz}, I_{OUT} = 0 \text{ mA},}{CE} = V_{IL}$		30	mA
VIL	Input Low Voltage		-0.6	0.8	V
VIH	Input High Voltage		2.0	Vcc + 0.5	V
VoL	Output Low Voltage	$I_{OL} = 2.1 \text{ mA}$		0.4	V
Vон	Output High Voltage	$I_{OH} = -400 \mu A$	2.4		V

Notes: 1. V<sub>CC</sub> must be applied simultaneously or before V<sub>PP</sub>, and removed simultaneously or after V<sub>PP</sub>.

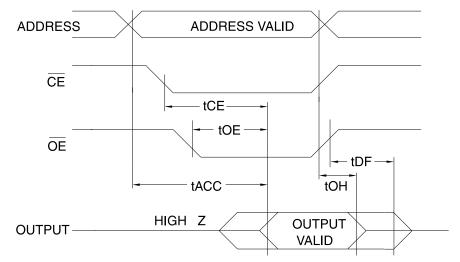
## **AC Characteristics for Read Operation**

				AT27C040							
				80		10		12		15	
Symbol	Parameter	Condition	Min	Max	Min	Max	Min	Max	Min	Max	Units
t <sub>ACC</sub> (3)	Address to Output Delay	CE = OE = V <sub>IL</sub>		80		100		120		150	ns
t <sub>CE</sub> (2)	CE to Output Delay	OE = VIL		80		100		120		150	ns
toE (2, 3)	OE to Output Delay	CE = V <sub>IL</sub>		35		35		35		40	ns
t <sub>DF</sub> (4, 5)	OE or CE High to Output Float, whicheve	r occurred first		30		30		30		30	ns
tон	Output Hold from Addr CE or OE, whichever of	ess, ccurred first	0		0		0		0		ns

Notes: 2, 3, 4, 5. - see AC Waveforms for Read Operation.

V<sub>PP</sub> may be connected directly to V<sub>CC</sub>, except during programming. The supply current would then be the sum of I<sub>CC</sub> and I<sub>PP</sub>.

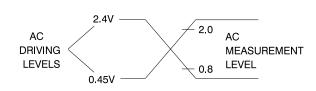
# **AC** Waveforms for Read Operation (1)



Notes: 1. Timing measurement references are 0.8V and 2.0V. Input AC drive levels are 0.45V and 2.4V, unless otherwise specified.

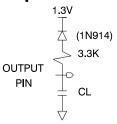
- 2. OE may be delayed up to tCE tOE after the falling edge of CE without impact on tCE.
- 3. OE may be delayed up to t<sub>ACC</sub> t<sub>OE</sub> after the address is valid without impact on t<sub>ACC</sub>.
- 4. This parameter is only sampled and is not 100% tested.
- Output float is defined as the point when data is no longer driven.

### **Input Test Waveforms and Measurement Levels**



 $t_R$ ,  $t_F < 20$  ns (10% to 90%)

#### **Output Test Load**



Note: CL = 100 pF including jig capacitance.

#### **Pin Capacitance** (f = 1 MHz, T = $25^{\circ}$ C)

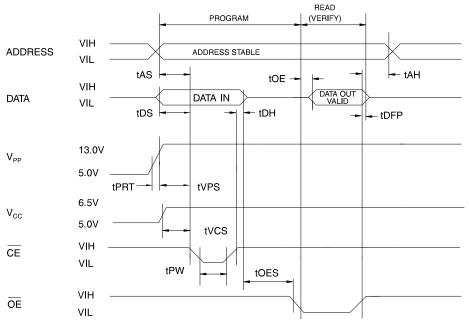
	Тур	Max	Units	Conditions
CIN	4	8	pF	$V_{IN} = 0V$
Cout	8	12	pF	$V_{OUT} = 0V$

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.





# **Programming Waveforms** (1)



Notes: 1. The Input Timing Reference is 0.8V for  $V_{IL}$  and 2.0V for  $V_{IH}$ .

- 2.  $t_{\text{OE}}$  and  $t_{\text{DFP}}$  are characteristics of the device but must be accommodated by the programmer.
- 3. When programming the AT27C040 a 0.1  $\mu$ F capacitor is required across V<sub>PP</sub> and ground to suppress spurious voltage transients.

## **DC Programming Characteristics**

 $T_{\text{A}}$  = 25  $\pm~$  5°C,  $V_{\text{CC}}$  = 6.5  $\pm~$  0.25V,  $V_{\text{PP}}$  = 13.0  $\pm~$  0.25V

		Test	L		
Symbol	Parameter	Conditions	Min	Max	Units
ILI	Input Load Current	$V_{IN} = V_{IL}, \ V_{IH}$		±10	μА
VIL	Input Low Level		-0.6	0.8	V
VIH	Input High Level		2.0	$V_{CC} + 0.7$	V
VoL	Output Low Voltage	$I_{OL} = 2.1 \text{ mA}$		0.4	V
VoH	Output High Voltage	$I_{OH} = -400 \mu A$	2.4		V
ICC2	V <sub>CC</sub> Supply Current (Program and Verify)			40	mA
IPP2	V <sub>PP</sub> Supply Current	$\overline{CE} = V_{IL}$		20	mA
V <sub>ID</sub>	A9 Product Identification Voltage		11.5	12.5	V

#### **AC Programming Characteristics**

 $T_{\text{A}}$  = 25  $\pm$  5°C,  $V_{\text{CC}}$  = 6.5  $\pm$  0.25V,  $V_{\text{PP}}$  = 13.0  $\pm$  0.25V

Sym- bol	T C Parameter	est Conditions* <sup>(1)</sup>	<b>Lir</b> Min	<b>nits</b> Max	Units
t <sub>AS</sub>	Address Setup Tim	ie	2		μS
toes	OE Setup Time		2		μS
tDS	Data Setup Time		2		μS
t <sub>AH</sub>	Address Hold Time	)	0		μS
t <sub>DH</sub>	Data Hold Time		2		μS
tDFP	OE High to Output Float Delay (2)		0	130	ns
tvps	V <sub>PP</sub> Setup Time		2		μS
tvcs	V <sub>CC</sub> Setup Time		2		μS
tpw	CE Program Pulse	e Width (3)	95	105	μS
toE	Data Valid from OE	(2)		150	ns
t <sub>PRT</sub>	V <sub>PP</sub> Pulse Rise Tim Programming	ne During	50		ns

#### \*AC Conditions of Test:

Notes: 1. V<sub>CC</sub> must be applied simultaneously or before V<sub>PP</sub> and removed simultaneously or after V<sub>PP</sub>.

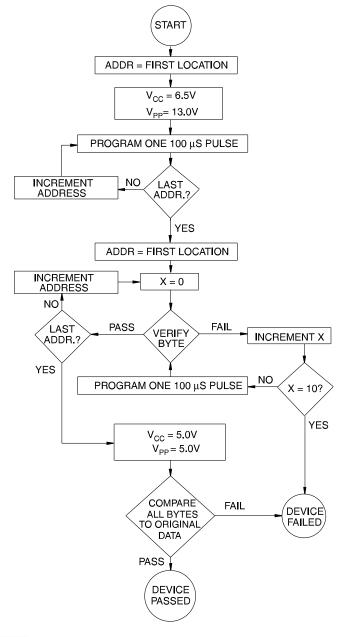
- This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven —see timing diagram.
- 3. Program Pulse width tolerance is 100  $\,\mu sec \pm 5\%$ .

# Atmel's 27C040 Integrated Product Identification Code

		Pins								Hex
Codes	A0	07	O6	O5	04	О3	02	01	00	Data
Manufacturer	0	0	0	0	1	1	1	1	0	1E
Device Type	1	0	0	0	0	1	0	1	1	0B

#### **Rapid Programming Algorithm**

A 100  $\mu s$   $\overline{CE}$  pulse width is used to program. The address is set to the first location.  $V_{CC}$  is raised to 6.5V and  $V_{PP}$  is raised to 13.0V. Each address is first programmed with one 100  $\mu s$   $\overline{CE}$  pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100  $\mu s$  pulses are applied with a verification after each pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked.  $V_{PP}$  is then lowered to 5.0V and  $V_{CC}$  to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.







# **Ordering Information**

tacc	()		0	Bardana	Outside Danie
(ns)	Active	Standby	Ordering Code	Package	Operation Range
80	30	0.1	AT27C040-80JC AT27C040-80PC AT27C040-80RC AT27C040-80TC	32J 32P6 32R 32T	Commercial (0°C to 70°C)
	30	0.1	AT27C040-80JI AT27C040-80PI AT27C040-80RI AT27C040-80TI	32J 32P6 32R 32T	Industrial (-40°C to 85°C)
100	30	0.1	AT27C040-10JC AT27C040-10PC AT27C040-10RC AT27C040-10TC	32J 32P6 32R 32T	Commercial (0°C to 70°C)
	30	0.1	AT27C040-10JI AT27C040-10PI AT27C040-10RI AT27C040-10TI	32J 32P6 32R 32T	Industrial (-40°C to 85°C)
120	30	0.1	AT27C040-12JC AT27C040-12PC AT27C040-12RC AT27C040-12TC	32J 32P6 32R 32T	Commercial (0°C to 70°C)
	30	0.1	AT27C040-12JI AT27C040-12PI AT27C040-12RI AT27C040-12TI	32J 32P6 32R 32T	Industrial (-40°C to 85°C)
150	30	0.1	AT27C040-15JC AT27C040-15PC AT27C040-15RC AT27C040-15TC	32J 32P6 32R 32T	Commercial (0°C to 70°C)
	30	0.1	AT27C040-15JI AT27C040-15PI AT27C040-15RI AT27C040-15TI	32J 32P6 32R 32T	Industrial (-40°C to 85°C)

Package Type	
32J	32 Lead, Plastic J-Leaded Chip Carrier (PLCC)
32P6	32 Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)
32R	32 Lead, 0.450" Wide, Plastic Gull Wing Small Outline (SOIC)
32T	32 Lead, Plastic Thin Small Outline Package (TSOP)